

To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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EOL announced Product

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Renesas Technology Home Page: <http://www.renesas.com>

Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

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2SD476(K), 2SD476A(K)

Silicon NPN Triple Diffused

RENESAS

ADE-208-898 (Z)

1st. Edition

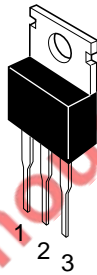
September 2000

Application

Power switching complementary pair with 2SB566(K) and 2SB566A(K)

Outline

TO-220AB



1. Base
2. Collector (Flange)
3. Emitter

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings		Unit
		2SD476(K)	2SD476A(K)	
Collector to base voltage	V_{CBO}	70	70	V
Collector to emitter voltage	V_{CEO}	50	60	V
Emitter to base voltage	V_{EBO}	5	5	V
Collector current	I_C	4	4	A
Collector peak current	$I_{C(peak)}$	8	8	A
Collector power dissipation	P_C^{*1}	40	40	W
Junction temperature	T_j	150	150	°C
Storage temperature	T_{stg}	-55 to +150	-55 to +150	°C

Note: 1. Value at $T_C = 25^\circ\text{C}$

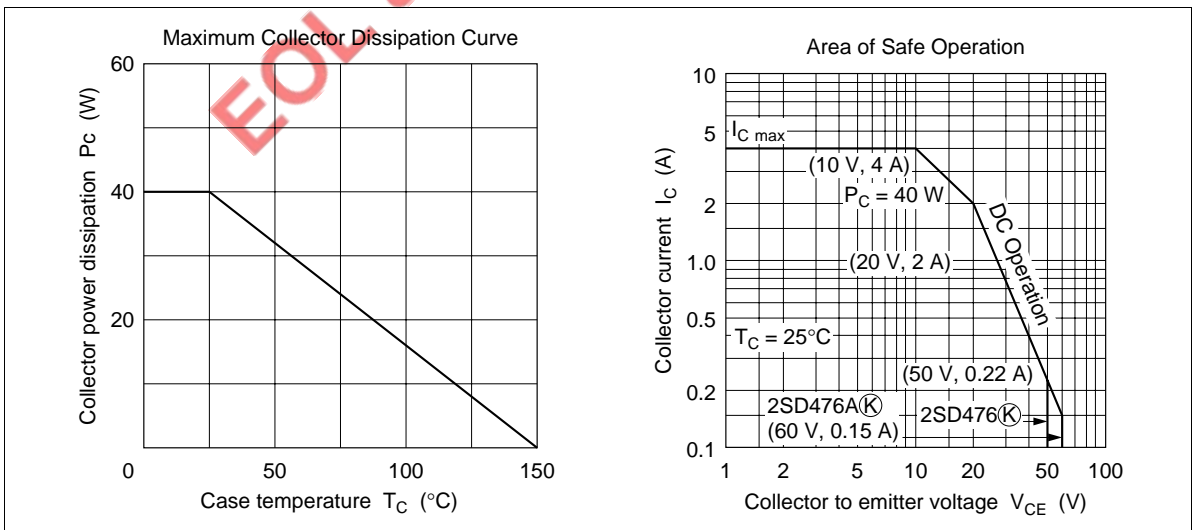
2SD476(K), 2SD476A(K)

Electrical Characteristics (Ta = 25°C)

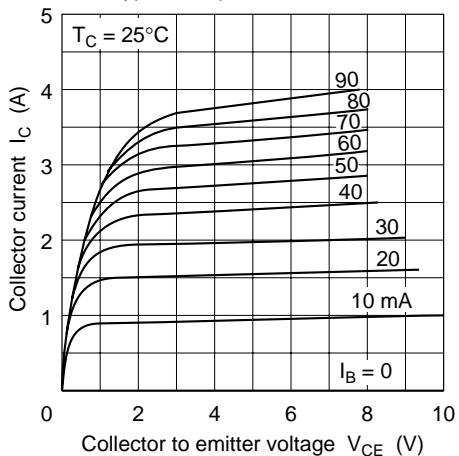
Item	Symbol	2SD476(K)			2SD476A(K)			Unit	Test conditions
		Min	Typ	Max	Min	Typ	Max		
Collector to base breakdown voltage	$V_{(BR)CBO}$	70	—	—	70	—	—	V	$I_C = 10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	50	—	—	60	—	—	V	$I_C = 50 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	—	—	5	—	—	V	$I_E = 10 \mu A, I_C = 0$
Collector cutoff current	I_{CBO}	—	—	1	—	—	1	μA	$V_{CB} = 50 \text{ V}, I_E = 0$
DC current transfer ratio	h_{FE1}	60	—	200	60	—	200		$V_{CE} = 4 \text{ V}, I_C = 1 \text{ A}$ (Pulse test)
	h_{FE2}	35	—	—	35	—	—		$V_{CE} = 4 \text{ V}, I_C = 0.1 \text{ A}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	1.0	—	—	1.0	V	$I_C = 2 \text{ A}, I_B = 0.2 \text{ A}$
Base to emitter saturation voltage	$V_{BE(sat)}$	—	—	1.2	—	—	1.2	V	
Gain bandwidth product	f_T	—	7	—	—	7	—	MHz	$V_{CE} = 4 \text{ V}, I_C = 0.5 \text{ A}$
Turn on time	t_{on}	—	0.3	—	—	0.3	—	μs	$V_{CC} = 10.5 \text{ V}$
Turn off time	t_{off}	—	3.0	—	—	3.0	—	μs	$I_C = 10 \text{ I}_{B1} = -10 \text{ I}_{B2} =$
Storage time	t_{stg}	—	2.5	—	—	2.5	—	μs	0.5 A

Note: 1. The 2SD476(K) and 2SD476A(K) are grouped by h_{FE1} as follows.

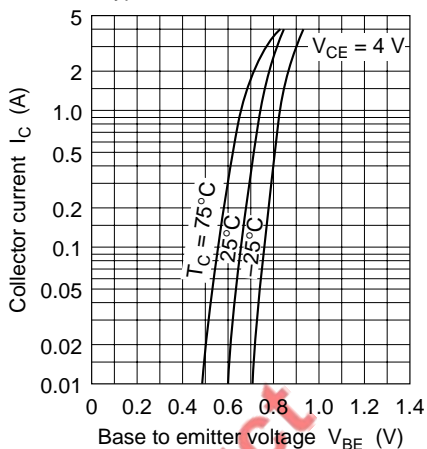
B	C
60 to 120	100 to 200



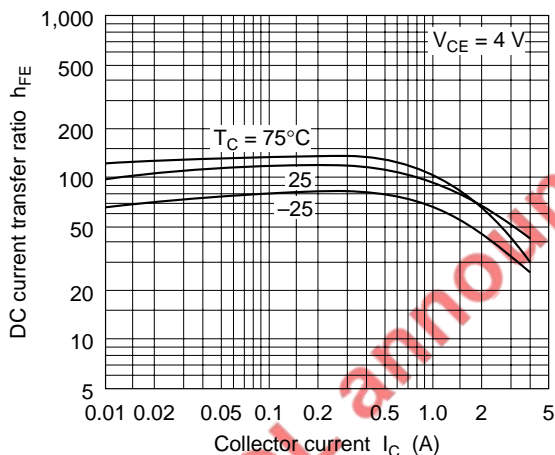
Typical Output Characteristics



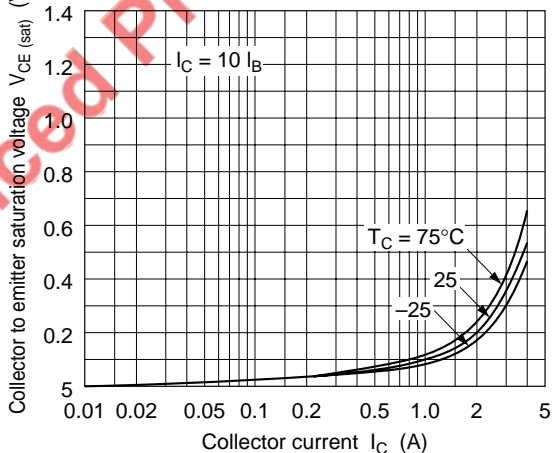
Typical Transfer Characteristics



DC Current Transfer Ratio vs. Collector Current



Collector to Emitter Saturation Voltage vs. Collector Current



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